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WPI / Thomson

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CPY - IDEK; IDEM

DC - A17 A81 G03

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IC - C08F8/46; C08F255/10; C09J123/26; C09J151/06

IN - ABURATANI R; KANAMARU M; MINAMI Y; TATSUMI T

LNKA- 2003-221769

MC - A04-G04 A10-E01 A12-A05B2 G03-B02D3

PA - (IDEK) IDEMITSU KOSAN CO LTD

- (IDEM) IDEMITSU PETROCHEM CO LTD

PN - W003070786 A1 20030828 DW200375
EP1477498 A1 20041117 DW200475
JP2003569693T T 20050609 DW200538
US2005245710 A1 20051103 DW200573
US7420023 B2 20080902 DW200859

PR - JP20020043543 20020220

XIC - C08F-008/46; C08F-010/00; C08F-010/08; C08F-255/00; C08F-255/10; C08F-257/00; C08F-257/02; C08F-008/00; C08L-023/00; C08L-023/20; C08L-051/00; C08L-051/06; C09J-123/00; C09J-123/20; C09J-151/00; C09J-151/06

AB - NOVELTY :

Manufacture of a modified butene-1 polymer comprises modifying a butene-1 polymer with a radical initiator and an organic acid. The butene-1 polymer is a crystalline resin which has (a) a melting point (Tm-D) of 0-100[deg]C; (b) a specified stereoregularity; and (c) a weight average molecular weight (Mw) of 10000-1000000 and Mw/Mn of <= 4.0.

- DETAILED DESCRIPTION :

Manufacture of a modified butene-1 polymer comprises modifying a butene-1 polymer with a radical initiator and an organic acid. The butene-1 polymer is a crystalline resin which has (a) a melting point (Tm-D) of 0-100[deg]C; (b) a stereoregularity shown by (mmmm)/((mmrr)+(rmmr)) optionally substituted at most 20; and (c) a weight average molecular weight (Mw) of 10000-1000000 and Mw/Mn of at most 4.0.

The melting point (Tm-D) is defined as the peak top of a peak observed at the maximum temperature side in a melting endothermic curve obtained by heating at 10[deg]C/minutes after retaining a sample at -10[deg]C for 5 minutes in a nitrogen atmosphere.

INDEPENDENT CLAIMS are also included for:

- (1) a modified butene-1 polymer; and
- (2) adhesive composition containing a modified butene-1 polymer.
- USE :

Used in adhesive compositions for adhering e.g. metal and paper. It is especially used as a hot-melt adhesive.

- ADVANTAGE :

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The modified butene-1 polymer can impart high adhesion, high strength, flexibility etc., to polyolefins etc. It gives a highly adhesive sealant or a polyolefin having improved compatibility with inorganic fillers etc.

- POLYMERS :
 - Preferred Method: The [mmmm] in the butene-1 polymer satisfies 20 <= [mmmm] <= 90 and [mmmm] <= 90 2 x [rr]. The butene-1 polymer is a butene-1 homopolymer or a copolymer of butene-1 and another 3-20C alpha -olefin which contains >= 90 mol% butene-1. The II-type crystallinity (CII) obtained by melting the polymer at 190[deg]C for 5 minutes, solidifying with ice water and analysing by X-ray diffraction after leaving at room temperature for 1 hour, is <= 50%. The modification reaction is performed in an organic solvent or in a melted state. The radical initiator is an organic peroxide and the organic acid is maleic acid anhydride or an acrylate. The modification reaction is performed in the co-presence of a styrene compound.
- EXAMPLE :
 - The butene-1 polymer is produced using (1,2'-dimethylsilylene)(2,1'-dimethylsilylene)-bis(3-trimethylsilylmethyl-indenyl) zirconium dichloride as a metallocene catalyst together with tri-isobutyl aluminum and methyl-aluminoxane. The butene-1 polymer (5.0g) and p-xylene (200ml) are introduced to a flask, and stirred for 30 minutes at 80[deg]C. An organic peroxide alpha ,alpha -bis(t-butylperoxy) di-isopropyl benzene (0.01g) and maleic acid anhydride (0.1g) are introduced and stirred at 140[deg]C for 60 minutes. After cooling to room temperature, it is introduced into methanol and the precipitate is filtered and dried to give the modified butene-1 polymer.
- DN JP US
- ICAI- C08F10/08; C08F255/00; C08F255/10; C08F257/02; C08F8/00; C08F8/46; C08L51/00; C08L51/06; C09J123/20; C09J151/00; C09J151/06
- ICAN- C08L23/20
- ICCI- C08F10/00; C08F255/00; C08F257/00; C08F8/00; C08L51/00; C09J123/00; C09J151/00
- ICCN- C08L23/00
- INW ABURATANI R; KANAMARU M; MINAMI Y; TATSUMI T
- IW MANUFACTURE MODIFIED BUTYLENE POLYMER SPECIFIED MELT POINT
 STEREOREGULAR MOLECULAR WEIGHT ORGANIC PEROXIDE RADICAL INITIATE ACID
 ADHESIVE
- IWW MANUFACTURE MODIFIED BUTYLENE POLYMER SPECIFIED MELT POINT

 STEREOREGULAR MOLECULAR WEIGHT ORGANIC PEROXIDE RADICAL INITIATE ACID
 ADHESIVE
- NC 26
- **NPN** 5
- OPD 2002-02-20
- PAW (IDEK) IDEMITSU KOSAN CO LTD
 - (IDEM) IDEMITSU PETROCHEM CO LTD
- PD 2003-08-28
- TI Manufacture of modified butene-1 polymer by modifying butene-1 polymer of specified melting point, stereoregularity and molecular weight, with organic peroxide radical initiator and organic acid, used in adhesives
- A01 [001] 018; R00805 G0055 G0044 G0033 G0022 D01 D02 D12 D10 D51 D53 D58

- D84 11179; H0000; S9999 S1387; S9999 S1627 S1605; M9999 M2813; M9999 M2835; M9999 M2368; M9999 M2299; M9999 M2062; L9999 L2391; L9999 L2062; L9999 L2299; L9999 L2368; L9999 L2813; L9999 L2835; K9449; P1150
- [002] 018; R00805 G0055 G0044 G0033 G0022 D01 D02 D12 D10 D51 D53 D58 D84 11179; G0033 G0022 D01 D02 D51 D53 D58 D83 D84 D85 D86 D87 D88 D89 D90 D91 D92 D93 D94; H0011; S9999 S1387; S9999 S1627 S1605; M9999 M2813; M9999 M2835; M9999 M2368; M9999 M2299; M9999 M2062; L9999 L2391; L9999 L2062; L9999 L2299; L9999 L2368; L9999 L2813; L9999 L2835; K9449; P1150
- [003] 018; ND03; ND07; B9999 B5094 B4977 B4740; B9999 B4944 B4922 B4740; K9676; K9574 K9483; K9552 K9483; K9563 K9483; Q9999 Q6666 Q6644; K9449; B9999 B5301 B5298 B5276; B9999 B4091 B3838 B3747; B9999 B4035 B3930 B3838 B3747; B9999 B4795 B4773 B4740; B9999 B5607 B5572; N9999 N5721; Q9999 Q9007; B9999 B3418 B3372; N9999 N6848 N6655; N9999 N6780 N6655
- [004] 018; D01 F48; C999 C088 C000; C999 C271
- [005] 018; D01 D11 D10 D19 D18 D31 D76 D50 D94 F48; C999 C088 C000; C999 C271
- [006] 018; D01 D11 D10 D21 D18 D34 D77 D54 D51 D57 D59 D62 D61 D68 D70 D95 F86 Cl 7A Zr 4B Tr; C999 C033 C000; C999 C293
- [007] 018; R00728 D01 D11 D10 D50 D68 D92 Al 3A 215; C999 C124 C113; C999 C293
- [008] 018; D00; A999 A237
- [009] 018; D01 G3430 D02 D11 D10 D19 D18 D31 D50 D76 D88; A999 A475
- A02 [001] 018; G0033 G0022 D01 D02 D51 D53; H0000; H0011; P1150
 - [002] 018; K9676; K9574 K9483; B9999 B5301 B5298 B5276; N9999 N5721
- A03 [001] 018; C999 C124 C113; C999 C293; P1923 P1912 D01 D10 D11 D50 D68 D81 A1 3A O- 6A
 - [002] 018; Q9999 Q6917

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